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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



BI-CMOSIC Three-Phase Brushless Motor Predriver for Variable Speed Control



The LV8105W is a predriver IC designed for variable speed control of 3-phase brushless motors. It can be used to implement a high- and low-side output n-channel power FET drive circuit using a built-in charge pump circuit. High-efficiency drive is possible through the use of low noise PWM drive and synchronous rectifying systems.

Functions

- Speed discriminator and PLL speed control system
- Built-in VCO circuit for generating the speed discriminator reference signal
- Speed lock detection output
- Hall bias switch
- Braking circuit (short braking)
- Full complement of on-chip protection circuits, including current limiter and lock protection circuits.

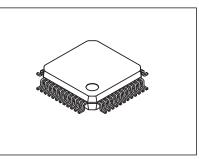
Specifications

Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage	V _{CC} max	V _{CC} = VG	42	V
Charge pump output voltage	VG max	VG pin	42	V
Output current	I _O max1	Pins UL, VL, WL	-15 to 15	mA
	I _O max2	Pins UH, VH, WH, UOUT, VOUT and WOUT	-20 to 20	mA
Allowable power dissipation	Pd max1	Independent IC	0.45	W
	Pd max2	Mounted on the specified board *	1.30	W
Operating temperature	Topr		-20 to +80	°C
Storage temperature	Tstg		-55 to +150	°C

* Specified board:114.3mm × 76.1mm × 1.6mm, glass epoxy board.

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.





ORDERING INFORMATION

See detailed ordering and shipping information on page 21 of this data sheet.



Allowable Operating range at $Ta = 25^{\circ}C$

Symbol	Conditions	Ratings	Unit
V _{CC}		16 to 28	V
IREG		0 to -10	mA
I _{HB}		0 to -25	mA
V _{LD}		0 to 6	V
I _{LD}		0 to 5	mA
V _{FGS}		0 to 6	V
I _{FGS}		0 to 5	mA
	V _{CC} I _{REG} I _{HB} V _{LD} I _{LD} V _{FGS}	V _{CC} I I _{REG} I I _{HB} VLD I _{LD} VFGS	V _{CC} 16 to 28 I _{REG} 0 to -10 I _{HB} 0 to -25 V _{LD} 0 to 6 I _{LD} 0 to 5 V _{FGS} 0 to 6

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Electrical Characteristics at Ta = 25°C, V_{CC} = 24V

Parameter	Symbol	Conditions		Ratings		Unit
i arameter	Gymbol	Conditions	min	typ	max	Onit
Supply current 1	ICC1			7	8.8	mA
Supply current 2	I _{CC} 2	At stop		3	3.8	mA
5V Constant-voltage Output (VREG	pin)					
Output voltage	VREG	I _O = 5mA	5.2	5.6	6.0	V
Line regulation	ΔV (REG1)	V _{CC} = 16 to 28V		10	50	mV
Load regulation	ΔV (REG2)	I _O = -5 to -10mA		10	50	mV
Output block / Conditions : apply a VC	voltage of 33V					
High level output voltage 1	V _{OH} 1	Pins UL, VL and WL I _{OH} = -2mA	VREG-0.65	VREG-0.5	VREG-0.35	V
Low level output voltage 1	V _{OL} 1	Pins UL, VL and WL I _{OL} = 2mA	0.35	0.5	0.65	V
High level output voltage 2	V _{OH} 2	Pins UH, VH and WH $I_{OH} = -2mA$	VG-0.65	VG-0.5	VG-0.35	V
Low level output voltage 2	V _{OL} 2	Pins UH, VH and WH $I_{OL} = 2mA$	0.45	0.6	0.8	V
PWM frequency	f (PWM)		51	64	77	kHz
Internal Oscillator						
Oscillation frequency	f (REF)		1.65	2.05	2.45	MHz
Charge Pump Output (VG pin)						
Output voltage	VGOUT		V _{CC} +8.0	V _{CC} +9.0	V _{CC} +10.0	V
CP1 pin						
High level output voltage	V _{OH} (CP1)	ICP1 = -2mA	V _{CC} -1.35	V _{CC} -1.0	V _{CC} -0.7	V
Low level output voltage	V _{OL} (CP1)	ICP1 = 2mA	0.5	0.65	0.8	V
Charge pump frequency	f (CP1)		102	128	154	kHz
Hall Amplifier	•	·	•		•	
Input bias current	IHB (HA)		-2	-0.1		μA
Common-mode input voltage range 1	VICM1	When using Hall elements	0.3		3.5	V
Common-mode input voltage range 2	VICM2	At one-side input bias (Hall IC application)	0		VREG	V
Hall input sensitivity		SIN wave	50			mVp-p
Hysteresis width	ΔV _{IN} (HA)		5	13	24	mV
Input voltage Low \rightarrow High	VSLH		2	7	12	mV
Input voltage High \rightarrow Low	VSHL		-12	-6	-2	mV
HB pin	•	·			•	
Output voltage	VHBO	IHB = -15mA	V _{CC} -0.8	V _{CC} -0.5	V _{CC} -0.35	V
Output leakage current	IL (HB)	$V_{O} = 0V$	-10			μA
FG Amplifier	· · · · ·					-
Input offset voltage	V _{IO} (FG)		-10		10	mV
Input bias current	IB (FG)		-1		1	μA
Reference voltage	VB (FG)		-5%	VREG/2	5%	V
High level output voltage	V _{OH} (FG)	IFGI = -0.1mA, No load	3.95	4.4	4.85	V
Low level output voltage	V _{OL} (FG)	IFGI = 0.1mA, No load	0.75	1.2	1.65	V
FG input sensitivity		GAIN : 100 times	3			mV
Schmitt width of the next stage		One-side hysteresis comparator	120	200	280	mV
Operation frequency range					3	kHz
Open-loop gain		f _{FG} = 2kHz	45	48	-	dB

Parameter	Symbol	Conditions		Ratings		Uni
Parameter	Symbol	Conditions	min	typ	max	Uni
FGS output						
Output saturation voltage	V _{OL} (FGS)	I _{FGS} = 2mA		0.2	0.4	V
Output leakage current	IL (FGS)	V _O = 6V			10	μA
CSD oscillator						
High level output voltage	V _{OH} (CSD)		2.9	3.4	3.9	V
Low level output voltage	V _{OL} (CSD)		1.6	2.0	2.4	V
Amplitude	V (CSD)		1.15	1.4	1.65	Vp-
External capacitor charge current	ICHG1		-13	-10	-7	μA
External capacitor discharge current	ICHG2		7.5	10.5	13.5	μA
Oscillation frequency	f (CSD)	C = 0.047µF		78		Hz
Speed Discriminator output						
High level output voltage 1	V _{OH} 1 (D)		VREG-1.25	VREG-1.0	VREG-0.75	V
Low level output voltage 1	V _{OL} 1 (D)		0.65	0.9	1.15	V
High level output voltage 2	V _{OH} 2 (D)		VREG-2.0	VREG-1.7	VREG-1.4	V
Low level output voltage 2	V _{OL} 2 (D)		1.3	1.6	1.9	V
Counts				512		
LD output	1	J	I	I	1	1
Output saturation voltage	V _{OL} (LD)	ILD = 2mA		0.2	0.4	V
Output leakage current	IL (LD)	V _O = 6V			10	μA
Lock range	. ,		-6.25		+6.25	. %
Speed control PLL output						
High level output voltage	V _{OH} (P)		VREG-2.0	VREG-1.7	VREG-1.4	V
Low level output voltage	V _{OL} (P)		1.3	1.6	1.9	V
Current control circuit	·OL (*)					
Drive gain	GDF		0.20	0.25	0.32	
Current limiter operation	GDI		0.20	0.23	0.02	
Limiter voltage	VRF		0.23	0.25	0.275	V
Integrator	VIII		0.20	0.20	0.270	•
Input offset voltage	Vic (INT)		-10		10	m\
	V _{IO} (INT)		-10		10	
Input bias current Reference voltage	IB (INT) VB (INT)		-1	VREG/2	5%	μA V
	. ,					v
High level output voltage	V _{OH} (INT)	I _{INT} I = -0.1mA, No load	3.95	4.4	4.85	
Low level output voltage	V _{OL} (INT)	I _{INT} I = 0.1mA, No load	0.75	1.2	1.65	V
Open-loop gain		f _{INT} = 2kHz	45	48		dE
VCO Oscillator (C pin)				1		
Oscillation frequency range	f (C)	C = 120pF, R = 24kΩ	0.15		1.54	MH
High level output voltage	V _{OH} (C)	FIL = 2.5V	2.71	3.16	3.61	V
Low level output voltage	V _{OL} (C)	FIL = 2.5V	2.20	2.60	3.00	V
Amplitude	V (C)	FIL = 2.5V	0.44	0.56	0.68	Vp-
FIL pin				1		
Output source current	I _{OH} (FIL)		-15	-11	-6	μA
Output sink current	I _{OL} (FIL)		6	10	15	μA
RC pin	1	1		1	1	
Comparator voltage	VRC		VREG×0.59	VREG×0.60	VREG×0.61	V
Low-voltage protection circuit			<u>.</u>		•	
Operation voltage	VLVSD		8.00	8.54	9.00	V
Hysteresis width	ΔVLVSD		0.25	0.34	0.45	V
Thermal shutdown operation						
Thermal shutdown operation	TSD	Design target value*	150	175		°C
				1	•	1

Note : * These items are design target values and are not tested.

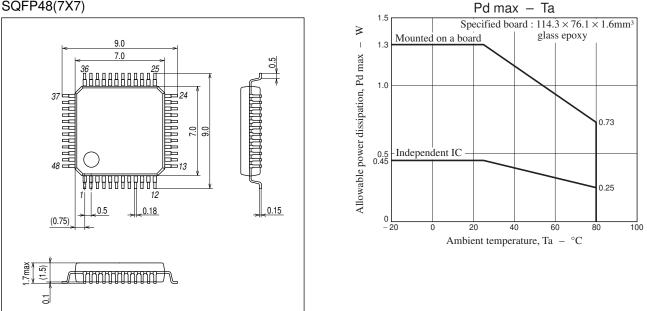
Parameter	Symbol	Conditions		Ratings			
Parameter	Symbol	Conditions	min	typ	max	Unit	
CLK pin							
Input frequency	fl (CLK)				3	kHz	
High level input voltage range	V _{IH} (CLK)		2.0		VREG	V	
Low level input voltage range	V _{IL} (CLK)		0		1.0	V	
Input open voltage	V _{IO} (CLK)		VREG-0.5		VREG	V	
Hysteresis width	V _{IS} (CLK)	Design target value*	0.18	0.27	0.36	V	
High level input current	I _{IH} (CLK)	VCLK = 5V	-22	-10	-3	μA	
Low level input current	IIL (CLK)	VCLK = 0V	-133	-93	-70	μA	
Pull-up resistance	RU (CLK)		45	60	75	kΩ	
S/S pin							
High level input voltage range	V _{IH} (S/S)		2.0		VREG	V	
Low level input voltage range	V _{IL} (S/S)		0		1.0	V	
Input open voltage	V _{IO} (S/S)		VREG-0.5		VREG	V	
Hysteresis width	V _{IS} (S/S)		0.18	0.27	0.36	V	
High level input current	I _{IH} (S/S)	VS/S = 5V	-22	-10	-3	μA	
Low level input current	I _{IL} (S/S)	VS/S = 0V	-133	-93	-70	μA	
Pull-up resistance	RU (S/S)		45	60	75	kΩ	
F/R pin							
High level input voltage range	V _{IH} (F/R)		2.0		VREG	V	
Low level input voltage range	V _{IL} (F/R)		0		1.0	V	
Input open voltage	V _{IO} (F/R)		VREG-0.5		VREG	V	
Hysteresis width	V _{IS} (F/R)		0.18	0.27	0.36	V	
High level input current	I _{IH} (F/R)	VF/R = 5V	-22	-10	-3	μA	
Low level input current	I _{IL} (F/R)	VF/R = 0V	-133	-93	-70	μA	
Pull-up resistance	RU (F/R)		45	60	75	kΩ	
BR pin							
High level input voltage range	V _{IH} (BR)		2.0		VREG	V	
Low level input voltage range	V _{IL} (BR)		0		1.0	V	
Input open voltage	V _{IO} (BR)		VREG-0.5		VREG	V	
Hysteresis width	V _{IS} (BR)		0.18	0.27	0.36	V	
High level input current	I _{IH} (BR)	VBR = 5V	-22	-10	-3	μA	
Low level input current	I _{IL} (BR)	VBR = 0V	-133	-93	-70	μA	
Pull-up resistance	RU (BR)		45	60	75	kΩ	

Note : * These items are design target values and are not tested.

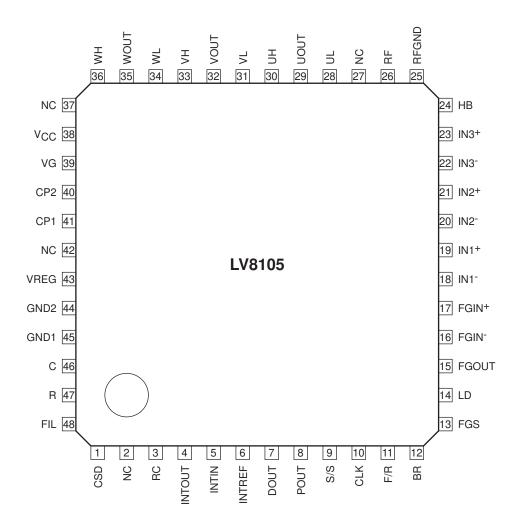
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Package Dimensions

unit : mm (typ) SQFP48(7X7)



Pin Assignment



		<u> </u>		ς υ	1			,
		F/R = "L"			F/R = "H"		Drive	output
	IN1	IN2	IN3	IN1	IN2	IN3	Upper gate	Lower gate
1	Н	L	Н	L	Н	L	VH	UL
2	Н	L	L	L	Н	Н	WH	UL
3	Н	Н	L	L	L	Н	WH	VL
4	L	Н	L	Н	L	Н	UH	VL
5	L	Н	Н	Н	L	L	UH	WL
6	L	L	Н	Н	Н	L	VH	WL

Three-phase logic truth table (A high level input is the state where $IN^+ > IN^-$.)

When F/R is "L", the Hall input while the motor is rotating must be input in order from 1 to 6 of the above table. When the Hall input is performed by the reverse order, it will not become the soft current-carrying output. (The motor is driven by the 120 degrees current-carrying only.)

Also, when F/R is "H", the Hall input while the motor is rotating must be input in order from 6 to 1 of the above table. When the Hall input is performed by the reverse order, it will not become the soft current-carrying output. (The motor is driven by the 120 degrees current-carrying only.)

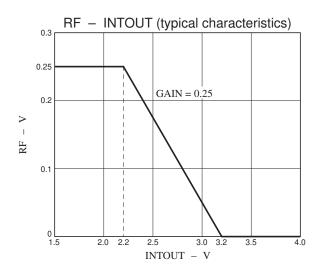
S/S Input

Input	Mode
High or Open	Stop
Low	Start

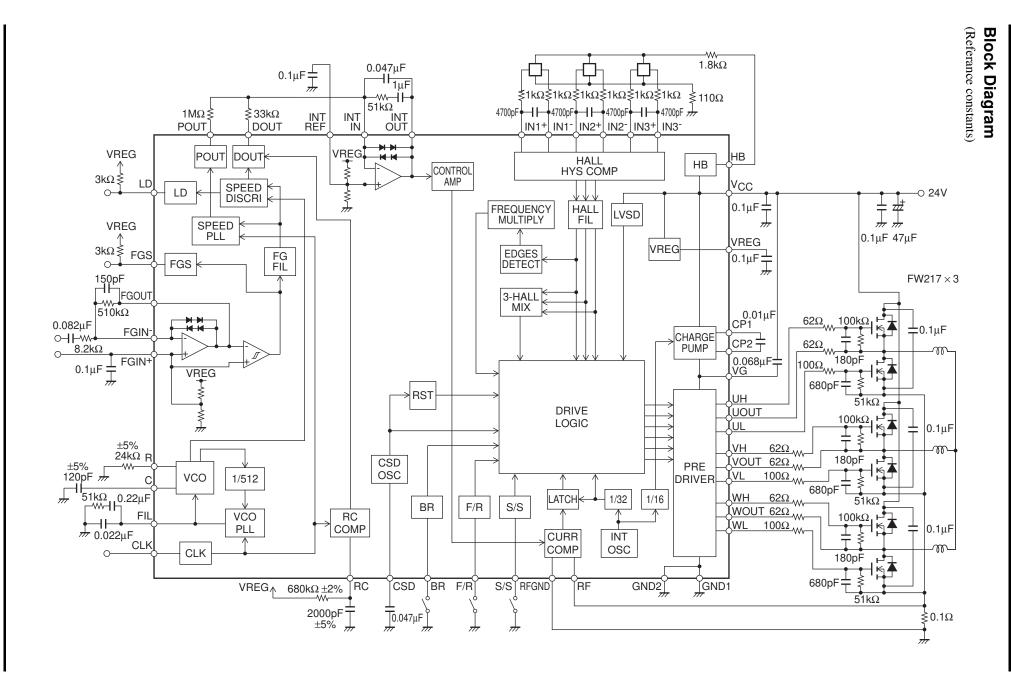
BR	Input
	mput

Input	Mode
High or Open	Brake
Low	Release

Current Control Characteristics



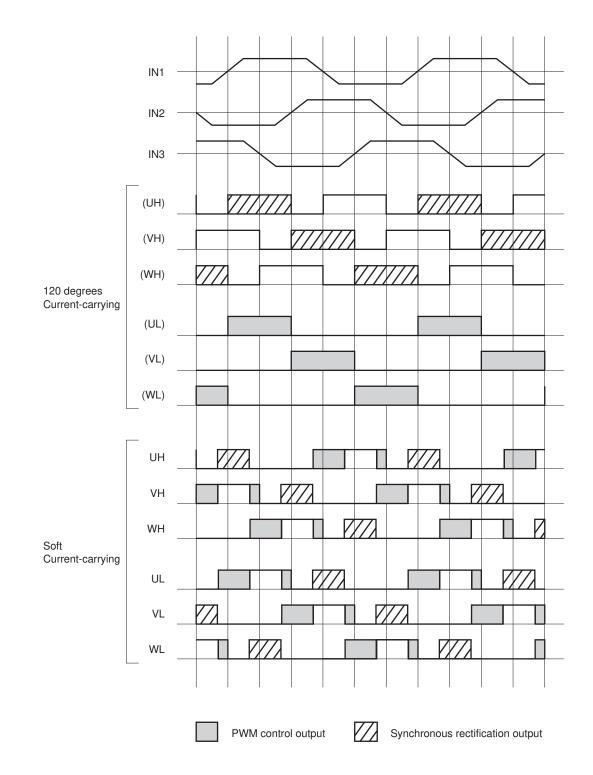




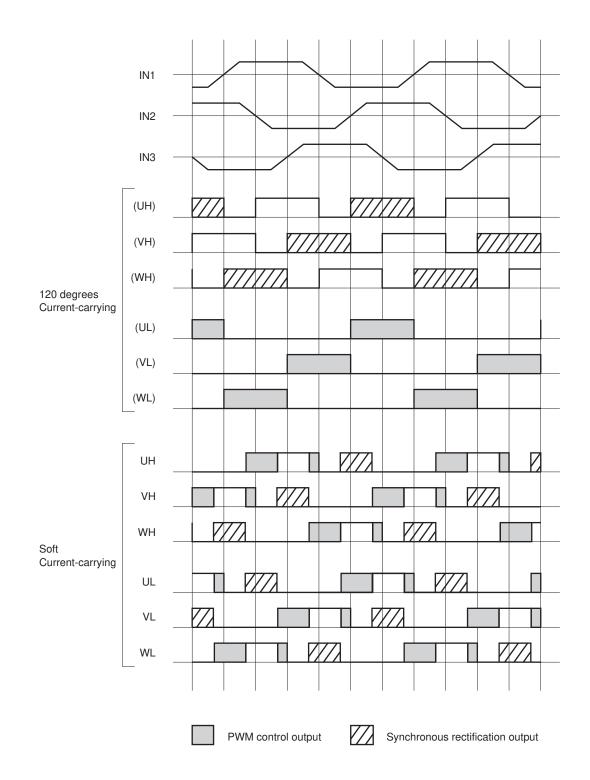
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Relations Hall input with Drive output

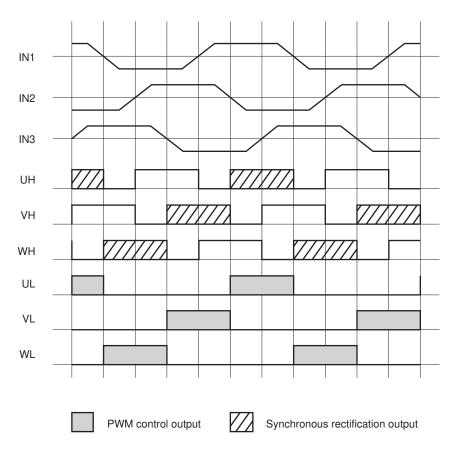
(1) When F/R = "L" and the soft current-carrying output.



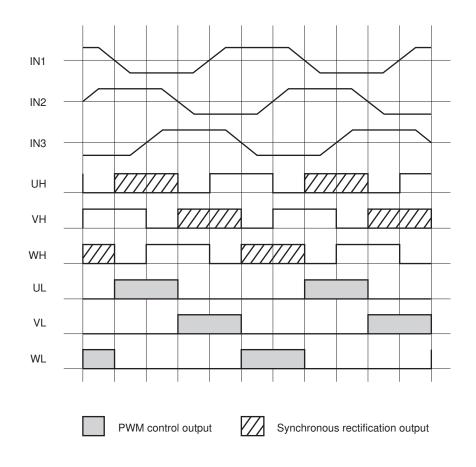
(2) When F/R = "H" and the soft current-carrying output.



(3) When F/R = "L" and the 120 degrees current-carrying only.



(4) When F/R="H" and the 120 degrees current-carrying only.



Pin Fu	nctions		
Pin No.	Pin name	Pin function	Equivalent circuit
1	CSD	Pin to set the operating time of the constraint protection. Connect a capacitor between this pin and GND. This pin combines also functions as the logic circuit block initial reset pin.	VREG VREG
3	RC	Pin to set the speed discriminator output amplitude switching circuit. Connect a capacitor between this pin and GND. And connect a resistor between VREG and this pin.	VREG
4	INTOUT	Integrating amplifier output pin.	VREG 4 4 π π π π π π π π
5	INTIN	Integrating amplifier inverting input pin.	$VREG$ $30k\Omega \lessapprox$
6	INTREF	Integrating amplifier non-inverting input pin. 1/2 VREG potential. Connect a capacitor between this pin and GND.	6 500Ω 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 5 5 30kΩ 5 30kΩ 5 5 5 30kΩ 5 5 30kΩ 5 5 30kΩ 5 30 30kΩ 5 30 30kΩ 5 30 30 30kΩ 5 30 30 30 30 30 30 30 30 30 30
7	DOUT	Speed discriminator output pin. Acceleration \rightarrow high, deceleration \rightarrow low.	VREG T T T T T T T T T T T T T

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Pin No. 8	Pin name POUT	Pin function Speed control PLL output pin.	Equivalent circuit
8	2001	Speed control PLL output pin. Outputs the phase comparison result for CLK and FG.	VREG
9	S/S	Start / Stop control pin. Low : 0V to 1.0V High : 2.0V to VREG Goes high when left open. Low for start. The hysteresis width is about 0.27V.	VREG 55kΩ \$ 55kΩ \$ 55kΩ \$ 9
10	CLK	External clock signal input pin. Low : 0V to 1.0V High : 2.0V to VREG Goes high when left open. The hysteresis width is about 0.27V. f = 3kHz, maximum.	VREG 55kΩ \$ 55kΩ \$ 5kΩ 10
11	F/R	Forward / reverse control pin. Low : 0V to 1.0V High : 2.0V to VREG Goes high when left open. Low for forward. The hysteresis width is about 0.27V.	VREG 55kΩ \$ 55kΩ \$ 5kΩ (11)
12	BR	Brake pin (short braking operation). Low : 0V to 1.0V High : 2.0V to VREG Goes high when left open. High or open for brake mode operation. The hysteresis width is about 0.27V.	VREG 55kΩ 55kΩ 5kΩ (12)

	from precedii		Г
Pin No.	Pin name	Pin function	Equivalent circuit
13	FGS	FG amplifier Schmitt output pin. This is an open collector output.	VREG () () () () () () () () () ()
14	LD	Lock detection output pin. This is an open collector output. Goes low when the motor speed is within the speed lock range (±6.25%).	VREG (14)
15	FGOUT	FG amplifier output pin. This pin is connected to the FG Schmitt comparator circuit internally in the IC.	VREG VREG (15) FG Schmitt comparator
16	FGIN⁻ FGIN⁺	FG amplifier inverting input pin. FG amplifier non-inverting input pin.	VREG 30kΩ \$
		1/2 VREG potential. Connect a capacitor between this pin and GND.	17 500Ω 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ 30kΩ
18 19 20 21 22 23	IN1 ⁻ IN1+ IN2- IN2+ IN3- IN3+	Hall input pins. The input is seen as a high level input when $IN^+ > IN^-$, and as a low level input for the opposite state. If noise on the Hall signals is a problem, insert capacitors between the corresponding IN^+ and IN^- inputs.	VREG (18/20/22) (18/20/22) (19/21/23) (19/21/23) (19/21/23) (Continued on next page.

Continued from preceding page.			
Pin No.	Pin name	Pin function	Equivalent circuit
24	НВ	Hall bias switch pin. Goes off when the S/S pin is the stop state.	
25	RFGND	Output current detection reference pin. Connect to GND side of the current detection resistor Rf.	$\frac{VREG}{2k\Omega}$
26	RF	Output current detection pin. Connect to the current detection resistor Rf. Sets the the maximum output current IOUT to be 0.25/Rf.	VREG
28 31 34	UL VL WL	Output pins for gate drive of the lower side N channel power FET.	VREG (28)31)34 (28)3

Continued	from precedin	ng page.	
Pin No.	Pin name	Pin function	Equivalent circuit
30	UH	Output pins for gate drive of the upper side N	VG
33	VH	channel power FET.	
36	WH		
			100Ω
29	UOUT	Pins to detect the source voltage of the upper side N	
32	VOUT	channel power FET.	
35	WOUT		
			* *
			<i>m m</i>
38	V _{CC}	Power supply pin.	
	00	Connect a capacitor between this pin and GND for	
		stabilization.	
39	VG	Charge pump output pin.	Vcc
		Connect a capacitor between this pin and $V_{CC}.$	
			≹ 400Ω
			⊥ 100Ω ≩
40	CP2	Pin to connect the capacitor for charge pump.	
		Connect a capacitor between this pin and CP1.	
			T T I
			<i>m m</i>
41	CP1	Pin to connect the capacitor for charge pump.	
		Connect a capacitor between this pin and CP2.	
			—₽ ▲
			m m
43	VREG	5V constant voltage output pin (5.6V).	Vcc
		Connect a capacitor between this pin and GND.	
			(43)
			the the the

Continued	Continued from preceding page.			
Pin No.	Pin name	Pin function	Equivalent circuit	
44	GND2	GND pins.		
45	GND1	GND1 and GND2 are connected in the IC.		
46	С	VCO oscillation pin. Connect a capacitor between this pin and GND.	VREG	
47	R	Pin to set the charge/discharge current of the VCO circuit. Connect a resistor between this pin and GND.	VREG	
48	FIL	VCO PLL output filter pin.	VREG (48)	
2 27 37 42	NC	No connection pins.		

Description of LV8105W

1. Speed control circuit

This IC controls the speed with a combination of the speed discriminator circuit and the PLL circuit. Therefore, when a motor that has large load variation is used, it is possible to prevent the rotation variation as compared with the speed control method only the speed discriminator. The speed discriminator circuit and the PLL circuit outputs an error signal once every one FG period. The FG servo frequency signal (f_{FG}) is controlled to have the equal frequency with the clock signal (f_{CLK}) which is input through the CLK pin.

 $f_{FG} = f_{CLK}$

2. VCO circuit

This IC has the VCO circuit to generate the reference signal of the speed discriminator circuit. The reference signal frequency is calculated as follows.

 $f_{VCO} = f_{CLK} \times 512$ f_{VCO} : Reference signal frequency, f_{CLK} : Clock signal frequency

The components connected to the R, C and FIL pins must be connected to the GND1 pin (pin 45) with a line that is as short as possible to reduce influence of noise.

3. Output drive circuit

This IC adopts a direct PWM drive method to reduce power loss in the output. An external output transistor is always saturated while the transistor is on and driving force of the motor is adjusted by changing the duty that the output transistor is on. The waveform of the coil current becomes trapezoidal with the current control and the overlap switching of about 15 degrees. Therefore, it is possible to reduce the motor noise and the torque ripple when switching the phase to which power is applied (Soft current-carrying).

When the 120 degrees current-carrying, the PWM switching is performed on the UL, VL and WL pins only. Also, when the soft current-carrying, the PWM switching is performed on any the outputs (the UL, VL, WL, UH, VH and WH pins). The PWM frequency is determined with 64kHz (typical) in the IC.

When the PWM switching of the upper side output is off, the lower side output is turned on. Also, when the PWM switching of the lower side output is off, the upper side output is turned on (Synchronous rectification). The off-time of the synchronous rectification is determined in the IC and varies from 1.2µs to 3.1µs.

4. Current limiter circuit

The current limiter circuit limits the (peak) current at the value $I = V_{RF}/Rf$ ($V_{RF} = 0.25V$ (typical), Rf: current detection resistor). The current limitation operation consists of reducing the PWM output on-duty to suppress the current.

High accuracy detection can be achieved by connecting the RF and RFGND pins lines near at the ends of the current detection resistor (Rf).

5. Speed lock range

The speed lock range is less than $\pm 6.25\%$ of the fixes speed. When the motor speed is in the lock range, the LD pin (an open collector output) goes low. If the motor speed goes out of the lock range, the on-duty of the motor drive output is adjusted according to the speed error to control the motor speed to be within the lock range.

As for the 120 degrees current-carrying and the soft current-carrying, when the motor speed goes out of the lock range, the current-carrying becomes the 120 degrees current-carrying. When the motor speed is within the lock range, the current-carrying becomes the soft current-carrying.

6. Speed discriminator output amplitude switching circuit

By the magnitude relation between the time t that is set by using the capacitor and resistor connected with the RC pin and the clock period which is input through the CLK pin, the output amplitude of the speed discriminator switches as follows.

	<high level="" output="" voltage=""></high>	<low level="" output="" voltage=""></low>
When the clock period is smaller than t	VREG-1.0V	0.9V
When the clock period is bigger than t	VREG-1.7V	1.6V

When connect a resistor R between the RC pin and VREG and a capacitor C between the RC pin and GND, the above time t is calculated as follows.

 $t = 0.91 \times R \times C$

By the variance of the IC, "0.91" of the above formula has varied from 0.885 to 0.935. When switching the output amplitude of the speed discriminator by the input voltage to the RC pin is performed, input that voltage to the RC pin through the resistor of $20k\Omega$.

The output amplitude of the speed discriminator is switched by the input voltage as follows.

	<high level="" output="" voltage=""></high>	<low level="" output="" voltage=""></low>
Low level input (0V to 2V),	VREG-1.0V	0.9V
High level input (4V to 6V),	VREG-1.7V	1.6V

When there is no need for the speed discriminator output amplitude switching, connect the RC pin with GND. In this instance, the high level output voltage of the speed discriminator becomes VREC-1.0V and the low level output voltage of the speed discriminator becomes 0.9V.

7. Hall input signal

The input amplitude of 100mVp-p or more (differential) is desirable in the Hall sensor inputs. The closer the input wave-form is to a square wave, the lower the required input amplitude. Inversely, a higher input amplitude is required the closer the input waveform is to a triangular wave. Also, note that the input DC voltage must be set to be within the common-mode input voltage range.

If a Hall sensor IC is used to provide the Hall inputs, those signals can be input to one side (either the + or - side) of the Hall sensor signal inputs as 0 to VREG level signals if the other side is held fixed at a voltage within the common-mode input voltage range that applies when the Hall sensors are used.

If noise on the Hall inputs is a problem, that noise must be excluded by inserting capacitors across the inputs. Those capacitors must be located as close as possible to the input pins.

When the Hall inputs for all three phases are in the same state, all the outputs will be in the off state.

The bias of the Hall element can be cut by supplying the bias of the Hall element from the HB pin while the S/S pin is a stop mode(Hall bias switch).

The Hall input frequency range possible for the soft current-carrying is determined from 30Hz to 500Hz (IN1 frequency).

8. S/S switching circuit

When the S/S pin is set to the low level, S/S switching circuit is the start mode. Inversely, when the S/S pin is set to the high level or open, S/S switching circuit is the stop mode. At the stop mode, all the outputs will be in the off state. This IC will be in the power save state of decreasing the supply current at the stop mode.

9. Braking circuit

When the BR pin is set to the high level or open, the brake is on. Inversely, when the BR pin is set to the low level, the brake is released. The brake becomes a short brake that turns on the lower side output transistors for all phases (the UL, VL and WL side) and turns off the upper side output transistors for all phases (the UH, VH and WH side). Note that the current limiter does not operate during braking. During braking, the duty is set to 100%, regardless of the motor speed. The current that flows in the output transistors during braking is determined by the motor back EMF voltage and the coil resistance. Applications must be designed so that this current does not exceed the ratings of the output transistors used. (The higher the motor speed at which braking is applied, the more severe this problem becomes).

The braking function can be applied and released with the IC at the start mode. This means that motor startup and stop control can be performed using the BR pin with the S/S pin held at the low level (the start mode). If the startup time becomes excessive, it can be reduced by controlling the motor startup and stop with the BR pin rather than with the S/S pin (Since the IC will be in the power save state at the stop mode, enough time for the VCO circuit to stabilize will be required at the beginning of the motor start operation).

10. Forward/Reverse switching circuit

The motor rotation direction can be switched by using the F/R pin. However, the following notes must be observed if the motor direction is switched while the motor is turning.

- This IC is designed to avoid through currents when switching directions. However, increases in the motor supply voltage (due to instantaneous return of the motor current to the power supply) during direction switching may cause problems. The values of the capacitors inserted between power and ground must be increased if this increase is excessive.
- If the motor current after direction switching exceeds the current limit value, the PWM drive side outputs will be turned off, but the opposite side output will be in the short-circuit braking state, and a current determined by the motor back EMF voltage and the coil resistance will flow. Applications must be designed so that this current does not exceed the ratings of the output transistors used. (The higher the motor speed at which the direction is switched, the more severe this problem becomes.)

11. Constraint protection circuit

The LV8105W includes an on-chip constraint protection circuit to protect the motor and the output transistors in motor constraint mode. If the LD output remains high (indicating the unlocked state) for a fixed period in the motor drive state (the S/S pin : start, the BR pin : brake release), the lower side output transistors (the UL, VL and WL side) are turned off. This time can be set by adjusting the oscillation frequency of the CSD pin by using a external capacitor. By the capacitance of the capacitor attached to the CSD pin, the set time is calculated as follows.

The set time (sec) = $60.8 \times C (\mu F)$

When a 0.047μ F capacitor is connected with the CSD pin, the set time becomes about 2.9sec. By the variance of the IC, "60.8" of the above formula has varied from 40.8 to 80.8. To restart a motor by cancelling the constraint protection function, any of the following operation is necessary.

• Put the S/S pin into the start state again after the stop state (about 1ms or more).

• Put the BR pin into the brake release state again after the braking state (about 1ms or more).

• Turn on the power supply again after the turn off state.

When the clock disconnect protection function, the thermal shutdown function and the low-voltage protection function are operating, the constraint protection function does not operate even if the motor does not rotate. The oscillation waveform of the CSD pin is used as the reference signal for some circuits in addition to the motor constraint protection circuit. Therefore, it is desirable to oscillate the CSD pin even if the constraint protection function is unnecessary. If the constraint protection circuit is not used, the oscillation of the CSD pin must be stopped by connecting a $220k\Omega$ resistor and a 0.01μ F capacitor in parallel between the CSD pin and GND. However, in that case, the clock disconnection protection circuit will no longer function. Also, the synchronous rectification does not operate in any of the following cases.

• When the motor does not rotate in the motor constrained state since the motor is started up by the S/S or the BR input, the PWM switching is performed by using the current limiter circuit. But, the synchronous rectification does not operate when the oscillation of the CSD pin is stopped.

The CSD pin combines also functions as the initial reset pin. The time that the CSD pin voltage is charged to about 1.25V is determined as the initial reset. At the initial reset, all the outputs will be in the off state.

12. Clock disconnection protection circuit

If the clock input through the CLK pin goes to the no input state in the motor drive state (the S/S pin : start, the BR pin : brake release), the lower side output transistors (the UL, VL and WL side) are turned off. If the clock is resupplied, the clock disconnection protection function is cancelled.

When the clock period is longer than about thirty-fourth part of the constraint protection set time, the clock disconnection protection circuit judges the clock input to be the no input state and this protection function will operate.

13. Thermal shutdown circuit

If the junction temperature rises to the specified temperature (TSD) in the motor drive state (the S/S pin : start, the BR pin : brake release), the lower side output transistors (the UL, VL and WL side) are turned off. If the junction temperature falls to more than the hysteresis width (Δ TSD), the thermal shutdown function is cancelled.

14. Low-voltage protection circuit

The LV8105W includes a low-voltage protection circuit to protect against incorrect operation when the V_{CC} power is applied or if the power supply voltage falls below its operating level. When the V_{CC} voltage falls under the specified voltage (VLVSD), all the outputs will be in the off state. If the V_{CC} voltage rises to more than the hysteresis width (Δ VLVSD), the low-voltage protection function is cancelled.

15. Power supply stabilization

Since this IC is used in applications that flow the large output current, the power supply line is subject to fluctuations. Therefore, capacitors with capacitance adequate to stabilize the power supply voltage must be connected between the V_{CC} pin and GND. If diodes are inserted in the power supply line to prevent the IC destruction due to reverse power supply connection, since this makes the power supply voltage even more subject to fluctuations, even larger capacitance will be required.

16. Ground lines

The signal system GND and the output system GND must be separated, and connected to one GND at the connector. As the large current flows to the output system GND, this GND line must be made as short as possible.

Output system GND : GND for Rf and V_{CC} line capacitors Signal system GND : GND for the IC and external components

17. Integrating amplifier

The integrating amplifier integrates the speed error pulses and phase error pulses and converts them to the speed command voltage. At that time it also sets the control loop gain and the frequency characteristics. External components of the integrating amplifier must be placed as close to the IC as possible to reduce influence of noise.

18. FG amplifier

The FG amplifier normally makes up a filter amplifier to reject noise. Since a clamp circuit has been added at the FG amplifier output, the output amplitude is clamped at about 3.2Vp-p, even if the amplifier gain is increased. After the FG amplifier, the Schmitt comparator on one side hysteresis(200mV (typical)) is inserted. The Schmitt comparator output (FGS output) becomes high level when the FG amplifier output is lower than the FGIN+ voltage, and becomes low level when the FG amplifier output is higher to more than Schmitt width as compared with the FGIN+ voltage. Therefore, it is desirable that the amplifier gain be set so that the output amplitude is over 1.0Vp-p at the lowest controlled speed to be used.

The capacitor connected between the FGIN⁺ pin and GND is required for bias voltage stabilization. This capacitor must be connected to the GND1 pin (pin 45) with a line that is as short as possible to reduce influence of noise. As the FG amplifier and the FGS output are operating even if the S/S pin is the stop state, it is possible to monitor the motor rotation by the FGS output.

ORDERING INFORMATION

Device	Package	Shipping (Qty / Packing)
LV8105W-MPB-E	SQFP48(7X7) (Pb-Free)	50 / Tray Foam
LV8105W-TLM-E	SQFP48(7X7) (Pb-Free)	1000 / Tape & Reel

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